



## Application:

Passive solution For Intel Xeon processor in 1U rack-mounted server.

## Specification:

Application System	1U Form Factor Passive Solution
CPU Type	Intel Xeon (Dempsey, Woodcrest, Clovertown)
Supported CPU Frequency	1.6-3.0 for Woodcrest, FSB 1333/1066 2.8-3.8 for Dempsey, FSB 1066/667
Socket Type	LGA 771
Heat Sink	Copper Base + Copper Stacked Fin
Cooler Dimension	88.9 x 78.8 x 27 mm
Fastener	Screw + Spring
Interface Material	Shin Etsu 7783
CEK Spring	Provide by Motherboard

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